# Sil-Pad® 2000

Higher Performance, High Reliability Insulator

#### **Features and Benefits**

- Thermal impedance: 0.33°C-in²/W (@50 psi)
- Complies with military standards
- · Optimal heat transfer
- High thermal conductivity: 3.5 W/m-K



Sil-Pad 2000 is a high performance, thermally conductive insulator designed for demanding military/aerospace and commercial applications. In these applications, Sil-Pad 2000 complies with military standards.

Sil-Pad 2000 is a silicone elastomer formulated to maximize the thermal and dielectric performance of the filler/binder matrix. The result is a grease-free, conformable material capable of meeting or exceeding the thermal and electrical requirements of high-reliability electronic packaging applications.

	Outgassing Data for Spacecraft Materials					
Post Cure Conditions	% TML (1.0% Max. Acceptable)	%CVCM (0.1% Max. Acceptable)				
24 hrs. @ 175°C No Post Cure	0.07 0.26	0.03 0.10				

TYPICAL PROPERTIES OF SIL-PAD 2000									
PROPERTY	IMPERIA	IMPERIAL VALUE METRIC VALUE		TEST METHOD					
Color	Wh	White		White		Visual			
Reinforcement Carrier	Fiberglass		Fiberglass		_				
Thickness (inch) / (mm)	0.0	0.010		0.254		ASTM D374			
Hardness (Shore A)	90		90		ASTM D2240				
Continuous Use Temp (°F) / (°C)	-76 to 392		-60 to 200		_				
ELECTRICAL									
Dielectric Breakdown Voltage (Vac)	40	4000		4000		ASTM D149			
Dielectric Constant (1000 Hz)	4.	4.0		4.0		ASTM D150			
Volume Resistivity (Ohm-meter)	10	10"		1011		ASTM D257			
Flame Rating	V-1	V-O		V-O		U.L.94			
THERMAL									
Thermal Conductivity (W/m-K)	3.	3.5		3.5		ASTM D5470			
THERMAL PERFORMANCE vs PRESSURE									
Pres	ssure (psi)	10	25	50	100	200			
TO-220 Thermal Performance (°C/W)		2.61	2.32	2.02	1.65	1.37			
Thermal Impedance (°C-in²/W) (I)		0.57	0.43	0.33	0.25	0.20			

I) The ASTM D5470 (Bergquist modified) test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied

### **Typical Applications Include:**

- Aerospace
- FSCM Number 55285
- Commercial
- U.L. File Number E59150

- Military Electronics
- High Voltage Power Supplies

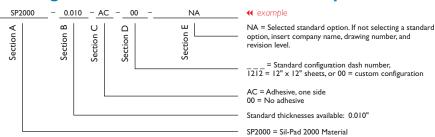
**Standard Options** 

- Avionics
- Military Specifications:
  - MIL-M-38527/8A
  - MIL-M-38527C
- MIL-I-49456

## **Configurations Available:**

- Sheet form and die-cut parts
- With or without pressure sensitive adhesive

## **Building a Part Number**



Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad  $^{\circ}$ : U.S. Patents 4,574,879; 4,602,125; 4,602,678; 4,685,987; 4,842,911 and others